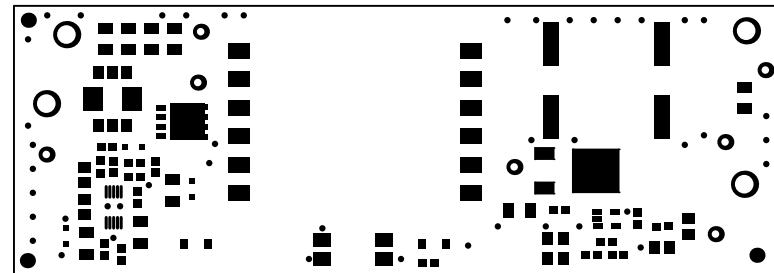
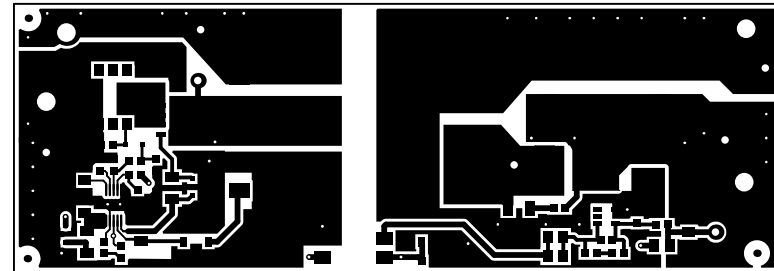


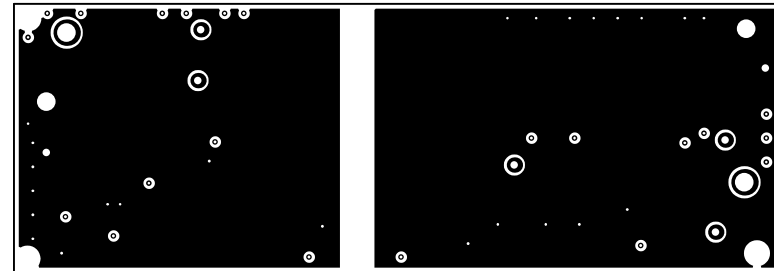
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7899	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 4/1/2015 5:30:11 PM	TEXAS INSTRUMENTS	



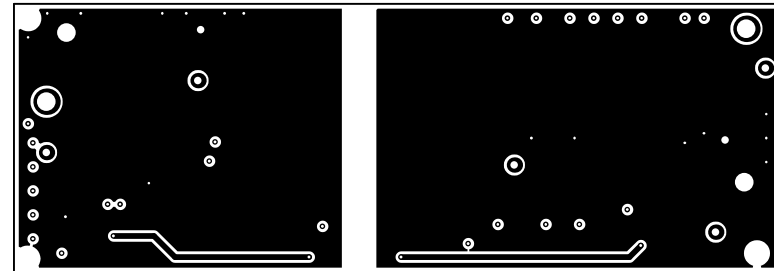
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7899	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 4/1/2015 5:30:12 PM	TEXAS INSTRUMENTS	



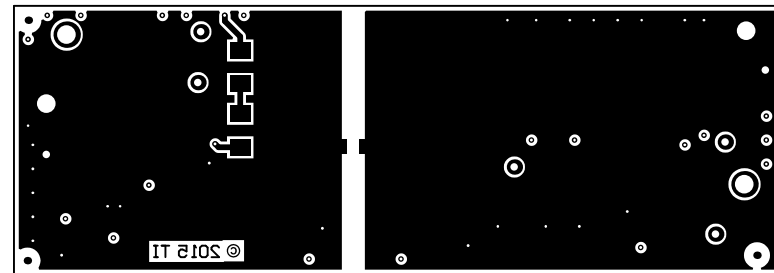
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7899	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Component Side			
PLOT NAME = Top Layer	GENERATED : 4/1/2015 5:30:13 PM	TEXAS INSTRUMENTS	



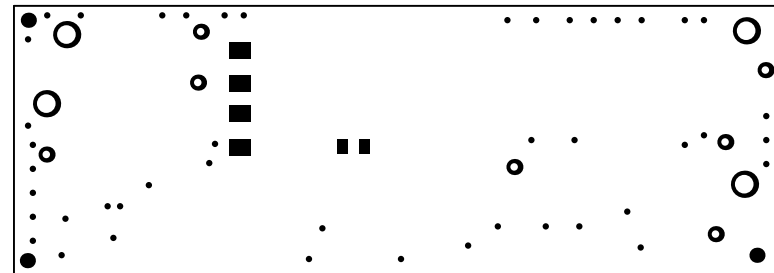
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7899	REV: B	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = MidLayer1	GENERATED : 4/1/2015 5:30:13 PM	TEXAS INSTRUMENTS	



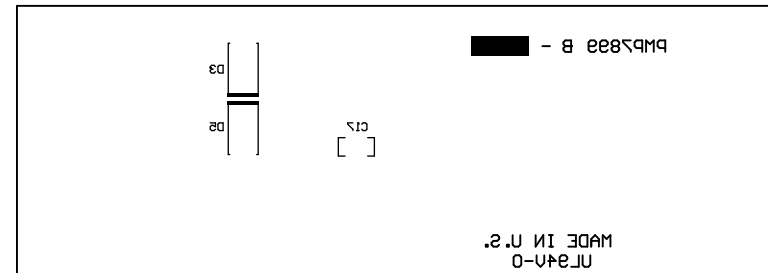
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7899	REV: B	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = MidLayer2	GENERATED : 4/1/2015 5:30:14 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7899	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Solder Side			
PLOT NAME = Bottom Layer	GENERATED : 4/1/2015 5:30:15 PM	TEXAS INSTRUMENTS	

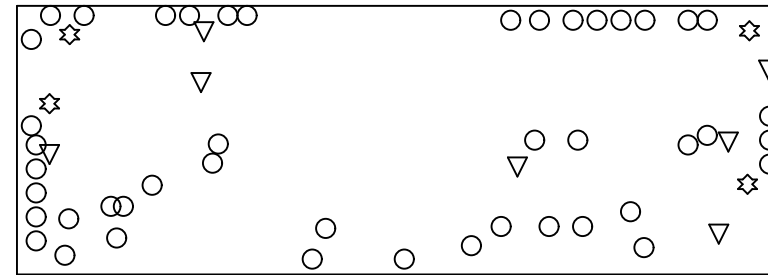


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7899	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 4/1/2015 5:30:16 PM	TEXAS INSTRUMENTS	

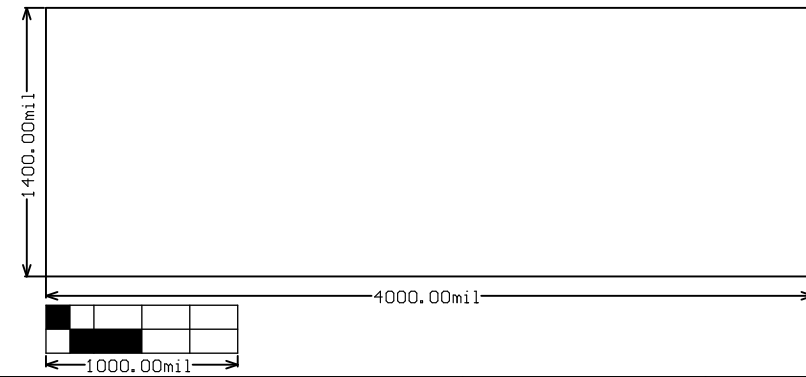


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7899	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 4/1/2015	5:30:16 PM	TEXAS INSTRUMENTS

Symbol	Quantity	Finished Hole Size	Plated	Hole Type
○	45	15,00mil (0,381mm)	PTH	Round
▽	7	40,00mil (1,016mm)	PTH	Round
☆	4	98,43mil (2,500mm)	PTH	Round
	56 Total			



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7899	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 4/1/2015	5:30:17 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP7899	REV: B	SUN REV: Not In VersionControl
LAYER NAME = Mechanical 2			
PLOT NAME = Board Dimensions	GENERATED : 4/1/2015	5:30:18 PM	TEXAS INSTRUMENTS

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